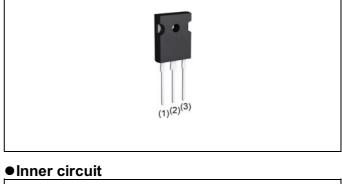
Nch 600V 30A Power MOSFET

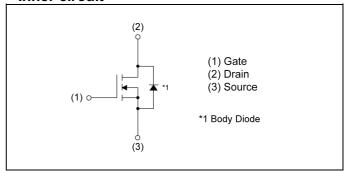
V_{DSS}	600V
R _{DS(on)} (Max.)	0.130Ω
I _D	±30A
P _D	305W

Outline
TO-247

Features

- 1) Low on-resistance
- 2) Ultra fast switching speed
- 3) Parallel use is easy
- 4) Pb-free plating; RoHS compliant





Application

Switching

Packaging specifications

Packing	Tube
Packing code	C13
Marking	R6030ENZ4
Quantity (pcs)	600

● **Absolute maximum ratings** (T_a = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit	
Drain - Source voltage		V_{DSS}	600	V
Continuous drain current (T _c = 25	5°C)	I _D *1	±30	А
Pulsed drain current		l _{DP} *2	±80	А
0.1.0	static	- V _{GSS}	±20	V
Gate - Source voltage	AC(f>1Hz)		±30	V
Avalanche current, single pulse		I _{AS}	5.2	Α
Avalanche energy, single pulse		E _{AS} *3	636	mJ
Power dissipation (T _c = 25°C)	P _D	305	W	
Junction temperature		T _j	150	°C
Operating junction and storage te	T _{stg}	-55 to +150	°C	

●Thermal resistance

Downwortow	Cymah al	Values			l lesi4
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R _{thJC} *4	-	-	0.41	°C/W
Thermal resistance, junction - ambient	R _{thJA}	-	-	30	°C/W
Soldering temperature, wavesoldering for 10s	T _{sold}	-	-	265	°C

● Electrical characteristics (T_a = 25°C)

Darameter	Cumb al	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic	
Drain - Source breakdown voltage	$V_{(BR)DSS}$ $V_{GS} = 0V, I_D = 1mA$		600	-	-	V	
		V _{DS} = 600V, V _{GS} = 0V					
Zero gate voltage drain current	I _{DSS}	$T_j = 25^{\circ}C$	-	-	100	μΑ	
		$T_j = 125^{\circ}C$	-	-	1000		
Gate - Source leakage current	I _{GSS}	V_{GS} = ±20V, V_{DS} = 0V	-	-	±100	nA	
Gate threshold voltage	$V_{GS(th)}$	V_{DS} = 10V, I_D = 1mA	2.0	-	4.0	٧	
		V _{GS} = 10V, I _D = 14.5A					
Static drain - source on - state resistance	R _{DS(on)} *5	$T_j = 25^{\circ}C$	-	0.115	0.130	Ω	
		$T_j = 125^{\circ}C$	-	0.255	-		
Gate resistance	R_{G}	f = 1MHz, open drain	-	3.6	-	Ω	

● Electrical characteristics (T_a = 25°C)

Darramatar	Cymah al	Conditions	Values			Unit	
Parameter	Symbol Conditions —		Min.	Тур.	Max.	Urill	
Input capacitance	C _{iss}	V _{GS} = 0V	-	2100	-		
Output capacitance	C _{oss}	V _{DS} = 25V	-	1900	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	190	-		
Turn - on delay time	t _{d(on)} *5	$V_{DD} \simeq 300V$, $V_{GS} = 10V$	-	40	-		
Rise time	t _r *5	I _D = 15A	-	55	-		
Turn - off delay time	t _{d(off)} *5	$R_L \simeq 20\Omega$	-	190	-	ns	
Fall time	t _f *5	$R_G = 10\Omega$	-	60	-		

●Gate charge characteristics (T_a = 25°C)

Darameter	Corrects al	Conditions	Values			Lloit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Total gate charge	Q_g^{*5}	V _{DD} ≈ 300V	-	85	-	
Gate - Source charge	Q _{gs} *5	I _D = 30A	-	15	-	nC
Gate - Drain charge	Q _{gd} *5	V _{GS} = 10V	-	45	-	
Gate plateau voltage	V _(plateau)	V _{DD} ≈ 300V, I _D = 30A	-	6.5	-	V

^{*1} Limited only by maximum channel temperature allowed.

^{*2} Pw ≤ 10µs, Duty cycle ≤ 1%

^{*3} L \doteqdot 50mH, V_{DD}=50V, R_G=25 Ω , Starting T_j=25°C

^{*4} T_C=25°C

^{*5} Pulsed

●Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit	
- Farameter	Symbol	Conditions	Min.	Тур.	Max.	Offic	
Source current			1	-	30	Α	
Pulsed source current	I _{SP} *2	T _C = 25°C	1	-	80	Α	
Source-Drain voltage V _{SD} *		$V_{GS} = 0V, I_{S} = 30A$	-	-	1.5	V	
Reverse recovery time	t _{rr} *5		-	660	-	ns	
Reverse recovery charge	Q _{rr} *5	I _S = 30A di/dt = 100A/μs	-	15	-	μC	
Peak reverse recovery current	_{rr} *5		-	45	-	Α	

Fig.1 Power Dissipation Derating Curve

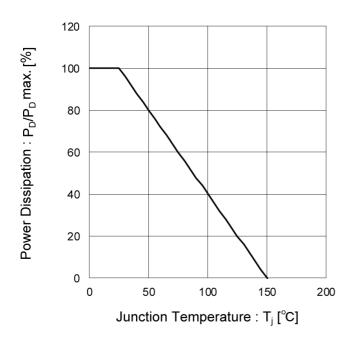


Fig.2 Drain Current Derating Curve

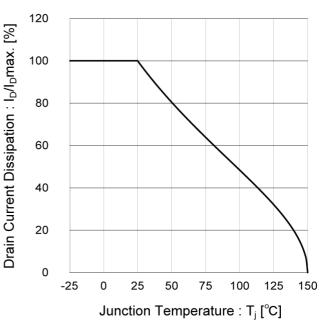


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

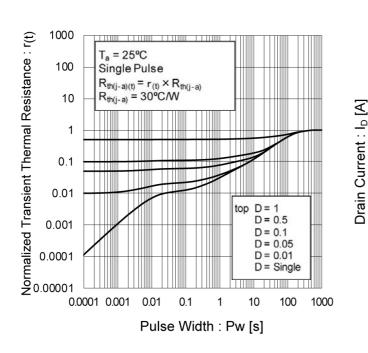


Fig.4 Maximum Safe Operating Area

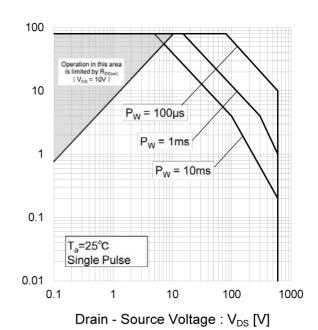


Fig.5 Avalanche Energy Derating Curve vs. Junction Temperature

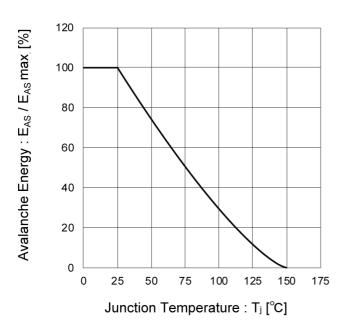


Fig.6 Normalized Breakdown Voltage vs. Junction Temperature

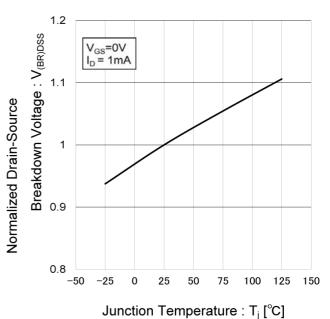


Fig.7 Typical Output Characteristics(I)

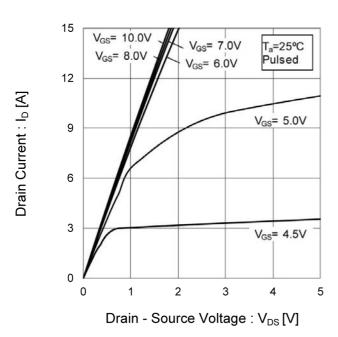
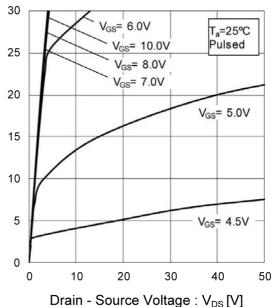


Fig.8 Typical Output Characteristics(II)



Drain Current : I_D [A]

Fig.9 Typical Transfer Characteristics

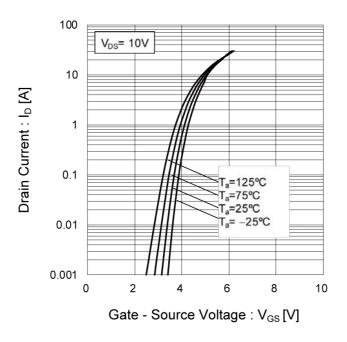


Fig.10 Gate Threshold Voltage vs. Junction Temperature

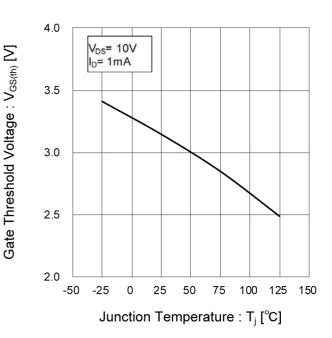


Fig.11 Static Drain - Source On - State Resistance vs. Drain Current

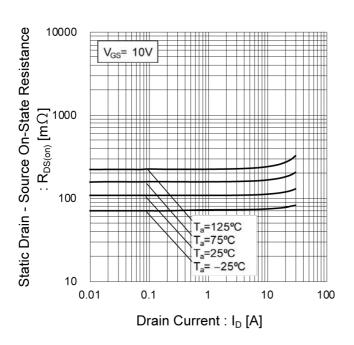


Fig.12 Static Drain - Source On - State Resistance vs. Gate - Source Voltage

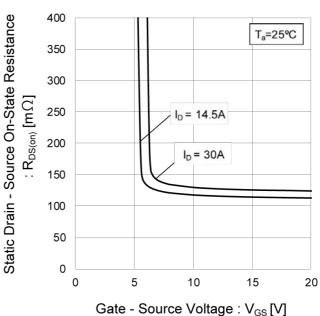


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

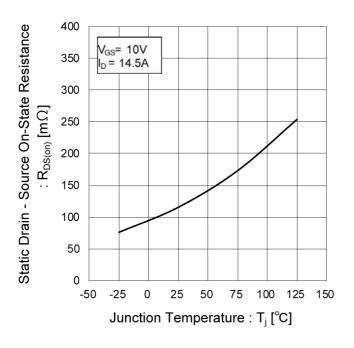


Fig.14 Typical Capacitance vs.
Drain - Source Voltage

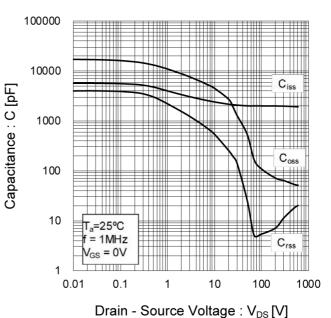


Fig.15 Switching Characteristics

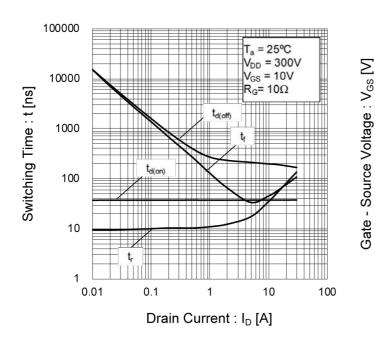


Fig.16 Typical Gate Charge

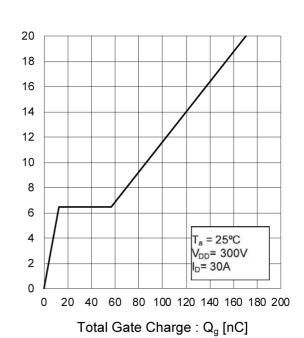


Fig.17 Source Current vs. Source - Drain Voltage

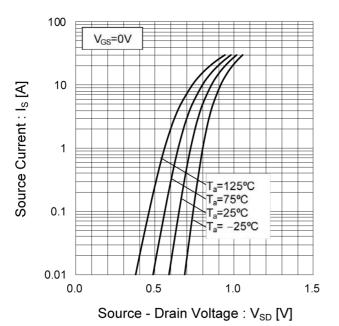
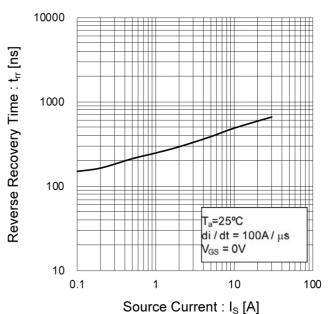


Fig.18 Reverse Recovery Time vs. Source Current



Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

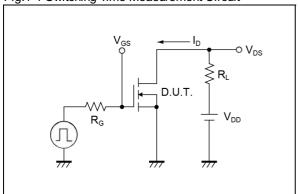


Fig.2-1 Gate Charge Measurement Circuit

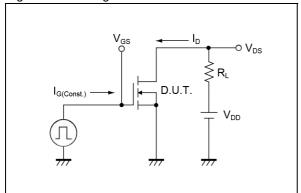


Fig.3-1 Avalanche Measurement Circuit

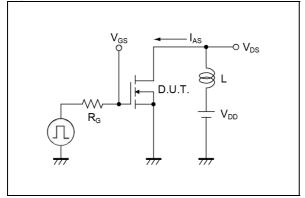


Fig.4-1 trr Measurement Circuit

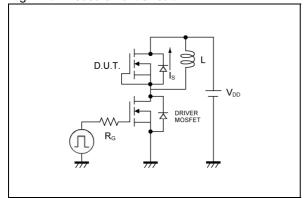


Fig.1-2 Switching Waveforms

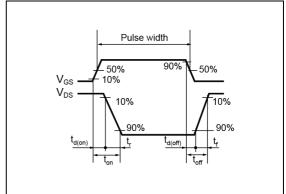


Fig.2-2 Gate Charge Waveform

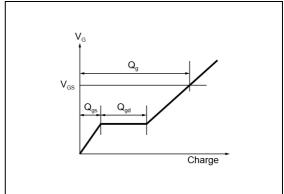


Fig.3-2 Avalanche Waveform

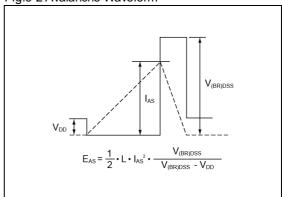
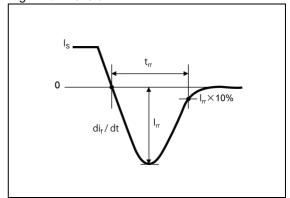
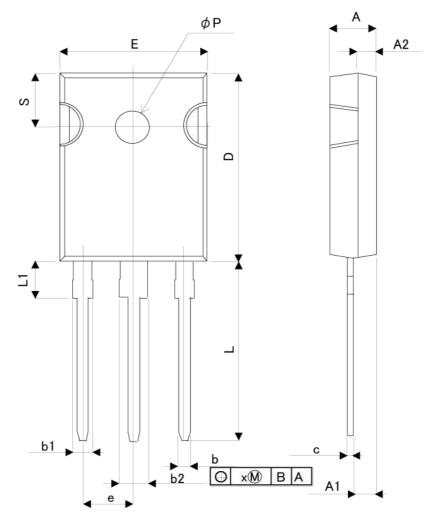


Fig.4-2 trr Waveform



Dimensions

TO-247



DIM	MILIME	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	4.82	5.22	0.190	0.206
A1	2.11	2.71	0.083	0.107
A2	1.80	2.20	0.071	0.087
b	1.00	1.40	0.039	0.055
b1	1.80	2.20	0.071	0.087
b2	2.80	3.20	0.110	0.126
С	0.45	0.75	0.018	0.030
D	20.65	21.25	0.813	0.837
E	15.64	16.24	0.616	0.639
е	5.4	14	0.2	14
L	19.77	20.37	0.778	0.802
L1	4.09	4.29	0.161	0.169
Р	3.51	3.71	0.138	0.146
S	5.97	6.37	0.235	0.251

Dimension in mm/inches



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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CL ACCTI
CLASSIV	CLASSIII	CLASSⅢ	CLASSIII

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 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
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- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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